

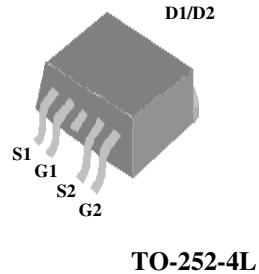


## ▼ Simple Drive Requirement

## ▼ Good Thermal Performance

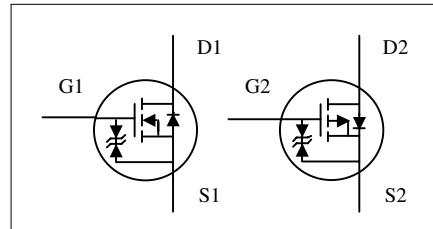
## ▼ Fast Switching Performance

## ▼ RoHS Compliant &amp; Halogen-Free

**Description**

|      |              |      |
|------|--------------|------|
| N-CH | $BV_{DSS}$   | 40V  |
|      | $R_{DS(ON)}$ | 24mΩ |
|      | $I_D$        | 8.7A |
| P-CH | $BV_{DSS}$   | -40V |
|      | $R_{DS(ON)}$ | 40mΩ |
|      | $I_D$        | -7A  |

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

**Absolute Maximum Ratings**

| Symbol                   | Parameter                             | Rating     |           | Units |
|--------------------------|---------------------------------------|------------|-----------|-------|
|                          |                                       | N-channel  | P-channel |       |
| $V_{DS}$                 | Drain-Source Voltage                  | 40         | -40       | V     |
| $V_{GS}$                 | Gate-Source Voltage                   | $\pm 20$   | $\pm 20$  | V     |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current <sup>3</sup> | 8.7        | -7.0      | A     |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current <sup>3</sup> | 7.0        | -5.6      | A     |
| $I_{DM}$                 | Pulsed Drain Current <sup>1</sup>     | 30         | -30       | A     |
| $P_D @ T_A = 25^\circ C$ | Total Power Dissipation               | 3.13       |           | W     |
| $T_{STG}$                | Storage Temperature Range             | -55 to 150 |           | °C    |
| $T_J$                    | Operating Junction Temperature Range  | -55 to 150 |           | °C    |

**Thermal Data**

| Symbol      | Parameter                                                 | Value | Unit |
|-------------|-----------------------------------------------------------|-------|------|
| $R_{thj-c}$ | Maximum Thermal Resistance, Junction-case                 | 6     | °C/W |
| $R_{thj-a}$ | Maximum Thermal Resistance, Junction-ambient <sup>3</sup> | 40    | °C/W |


**N-CH Electrical Characteristics@  $T_j=25^\circ\text{C}$ (unless otherwise specified)**

| Symbol                   | Parameter                                      | Test Conditions                                            | Min. | Typ. | Max.     | Units            |
|--------------------------|------------------------------------------------|------------------------------------------------------------|------|------|----------|------------------|
| $\text{BV}_{\text{DSS}}$ | Drain-Source Breakdown Voltage                 | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$     | 40   | -    | -        | V                |
| $R_{\text{DS(ON)}}$      | Static Drain-Source On-Resistance <sup>2</sup> | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=7\text{A}$         | -    | -    | 24       | $\text{m}\Omega$ |
|                          |                                                | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=5\text{A}$        | -    | -    | 36       | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$      | Gate Threshold Voltage                         | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$ | 1    | -    | 3        | V                |
| $g_{\text{fs}}$          | Forward Transconductance                       | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=7\text{A}$         | -    | 14   | -        | S                |
| $I_{\text{DSS}}$         | Drain-Source Leakage Current                   | $V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$        | -    | -    | 10       | $\mu\text{A}$    |
| $I_{\text{GSS}}$         | Gate-Source Leakage                            | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$    | -    | -    | $\pm 30$ | $\mu\text{A}$    |
| $Q_g$                    | Total Gate Charge <sup>2</sup>                 | $I_{\text{D}}=7\text{A}$                                   | -    | 8    | 13       | nC               |
| $Q_{\text{gs}}$          | Gate-Source Charge                             | $V_{\text{DS}}=32\text{V}$                                 | -    | 1.7  | -        | nC               |
| $Q_{\text{gd}}$          | Gate-Drain ("Miller") Charge                   | $V_{\text{GS}}=4.5\text{V}$                                | -    | 4.4  | -        | nC               |
| $t_{\text{d(on)}}$       | Turn-on Delay Time <sup>2</sup>                | $V_{\text{DS}}=20\text{V}$                                 | -    | 6    | -        | ns               |
| $t_r$                    | Rise Time                                      | $I_{\text{D}}=7\text{A}$                                   | -    | 16   | -        | ns               |
| $t_{\text{d(off)}}$      | Turn-off Delay Time                            | $R_{\text{G}}=3.3\Omega, V_{\text{GS}}=10\text{V}$         | -    | 17   | -        | ns               |
| $t_f$                    | Fall Time                                      | $R_{\text{D}}=2.86\Omega$                                  | -    | 4    | -        | ns               |
| $C_{\text{iss}}$         | Input Capacitance                              | $V_{\text{GS}}=0\text{V}$                                  | -    | 600  | 960      | pF               |
| $C_{\text{oss}}$         | Output Capacitance                             | $V_{\text{DS}}=25\text{V}$                                 | -    | 110  | -        | pF               |
| $C_{\text{rss}}$         | Reverse Transfer Capacitance                   | f=1.0MHz                                                   | -    | 75   | -        | pF               |
| $R_g$                    | Gate Resistance                                | f=1.0MHz                                                   | -    | 2.1  | -        | $\Omega$         |

**Source-Drain Diode**

| Symbol          | Parameter                          | Test Conditions                                     | Min. | Typ. | Max. | Units |
|-----------------|------------------------------------|-----------------------------------------------------|------|------|------|-------|
| $V_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $I_{\text{S}}=2.6\text{A}, V_{\text{GS}}=0\text{V}$ | -    | -    | 1.2  | V     |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>2</sup> | $I_{\text{S}}=7\text{A}, V_{\text{GS}}=0\text{V}$   | -    | 19   | -    | ns    |
| $Q_{\text{rr}}$ | Reverse Recovery Charge            | $dI/dt=100\text{A}/\mu\text{s}$                     | -    | 13   | -    | nC    |

**P-CH Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)**

| Symbol                     | Parameter                                      | Test Conditions                                             | Min. | Typ. | Max.     | Units            |
|----------------------------|------------------------------------------------|-------------------------------------------------------------|------|------|----------|------------------|
| $\text{BV}_{\text{DSS}}$   | Drain-Source Breakdown Voltage                 | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$     | -40  | -    | -        | V                |
| $R_{\text{DS}(\text{ON})}$ | Static Drain-Source On-Resistance <sup>2</sup> | $V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-5\text{A}$        | -    | -    | 40       | $\text{m}\Omega$ |
|                            |                                                | $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-3\text{A}$       | -    | -    | 65       | $\text{m}\Omega$ |
| $V_{\text{GS}(\text{th})}$ | Gate Threshold Voltage                         | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$ | -1   | -    | -3       | V                |
| $g_{\text{fs}}$            | Forward Transconductance                       | $V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-5\text{A}$        | -    | 10   | -        | S                |
| $I_{\text{DSS}}$           | Drain-Source Leakage Current                   | $V_{\text{DS}}=-40\text{V}, V_{\text{GS}}=0\text{V}$        | -    | -    | -10      | $\text{uA}$      |
| $I_{\text{GSS}}$           | Gate-Source Leakage                            | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$     | -    | -    | $\pm 30$ | $\text{uA}$      |
| $Q_g$                      | Total Gate Charge <sup>2</sup>                 | $I_{\text{D}}=-5\text{A}$                                   | -    | 13   | 21       | nC               |
| $Q_{\text{gs}}$            | Gate-Source Charge                             | $V_{\text{DS}}=-32\text{V}$                                 | -    | 2    | -        | nC               |
| $Q_{\text{gd}}$            | Gate-Drain ("Miller") Charge                   | $V_{\text{GS}}=-4.5\text{V}$                                | -    | 8.5  | -        | nC               |
| $t_{\text{d}(\text{on})}$  | Turn-on Delay Time <sup>2</sup>                | $V_{\text{DS}}=-20\text{V}$                                 | -    | 8    | -        | ns               |
| $t_r$                      | Rise Time                                      | $I_{\text{D}}=-5\text{A}$                                   | -    | 15   | -        | ns               |
| $t_{\text{d}(\text{off})}$ | Turn-off Delay Time                            | $R_G=3.3\Omega, V_{\text{GS}}=-10\text{V}$                  | -    | 26   | -        | ns               |
| $t_f$                      | Fall Time                                      | $R_D=4\Omega$                                               | -    | 34   | -        | ns               |
| $C_{\text{iss}}$           | Input Capacitance                              | $V_{\text{GS}}=0\text{V}$                                   | -    | 670  | 1070     | pF               |
| $C_{\text{oss}}$           | Output Capacitance                             | $V_{\text{DS}}=-25\text{V}$                                 | -    | 160  | -        | pF               |
| $C_{\text{rss}}$           | Reverse Transfer Capacitance                   | $f=1.0\text{MHz}$                                           | -    | 135  | -        | pF               |
| $R_g$                      | Gate Resistance                                | $f=1.0\text{MHz}$                                           | -    | 6    | -        | $\Omega$         |

**Source-Drain Diode**

| Symbol          | Parameter                          | Test Conditions                             | Min. | Typ. | Max. | Units |
|-----------------|------------------------------------|---------------------------------------------|------|------|------|-------|
| $V_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $I_S=-2.6\text{A}, V_{\text{GS}}=0\text{V}$ | -    | -    | -1.2 | V     |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>2</sup> | $I_S=-5\text{A}, V_{\text{GS}}=0\text{V}$   | -    | 28   | -    | ns    |
| $Q_{\text{rr}}$ | Reverse Recovery Charge            | $dI/dt=-100\text{A}/\mu\text{s}$            | -    | 23   | -    | nC    |

**Notes:**

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test.
- 3.N-CH , P-CH are same , mounted on 2oz FR4 board  $t \leq 10\text{s}$ .

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

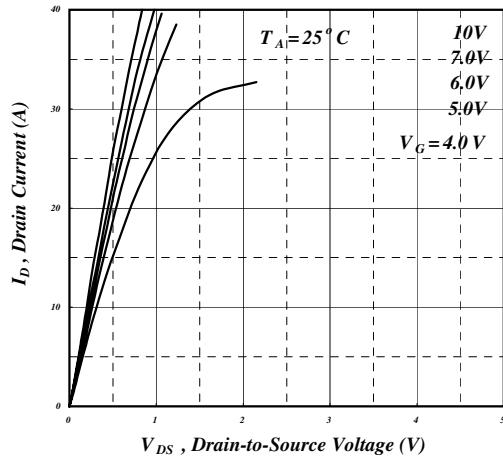
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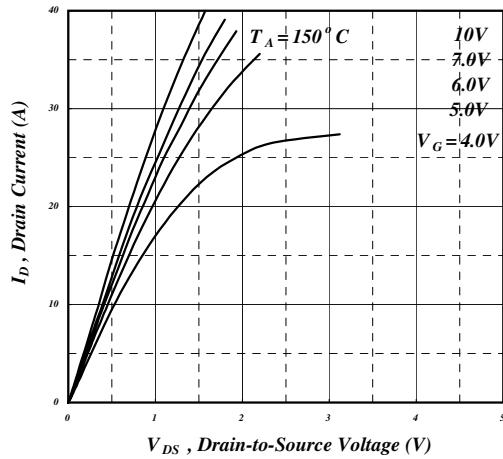
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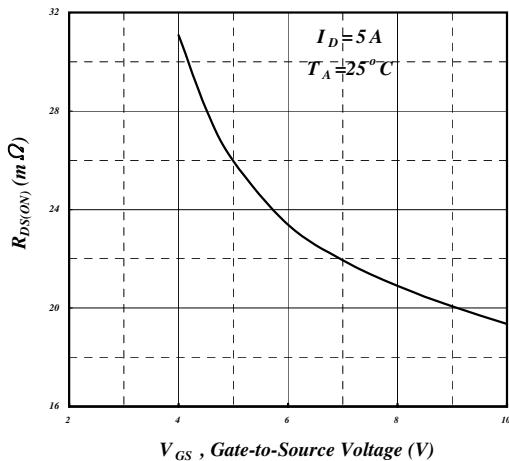
## N-Channel



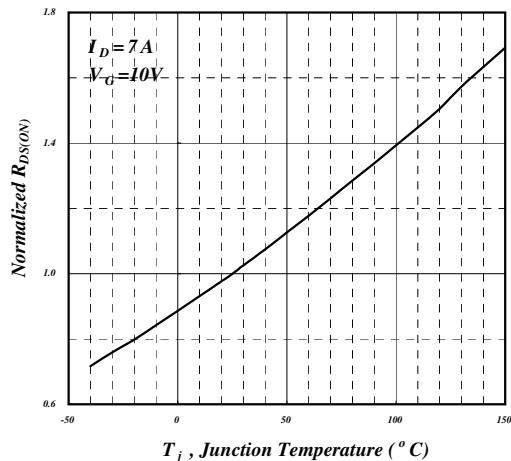
**Fig 1. Typical Output Characteristics**



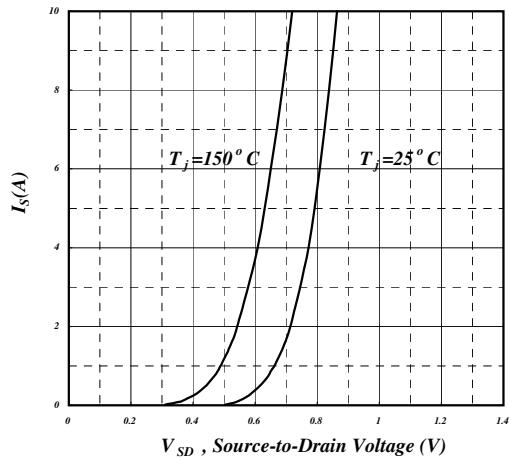
**Fig 2. Typical Output Characteristics**



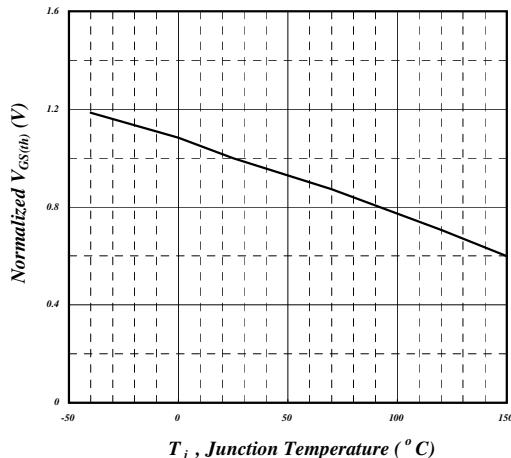
**Fig 3. On-Resistance v.s. Gate Voltage**



**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



**Fig 5. Forward Characteristic of Reverse Diode**

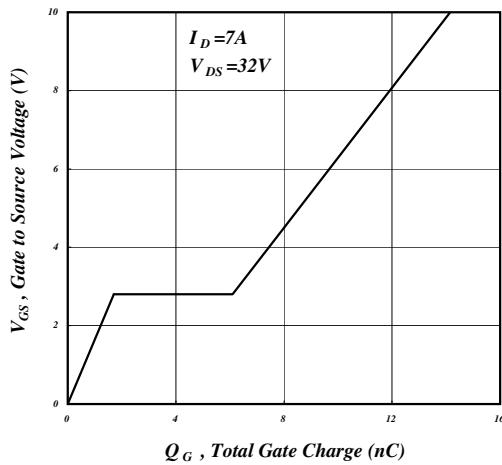


**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**

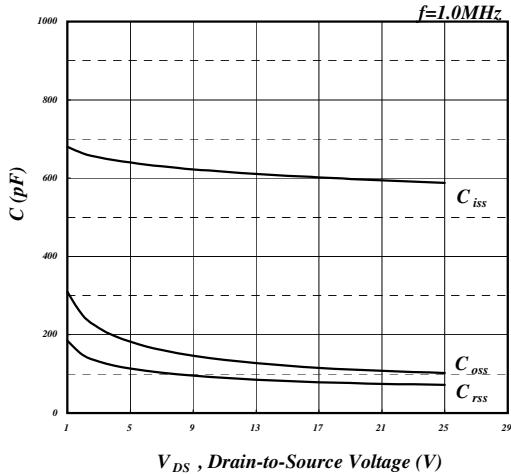


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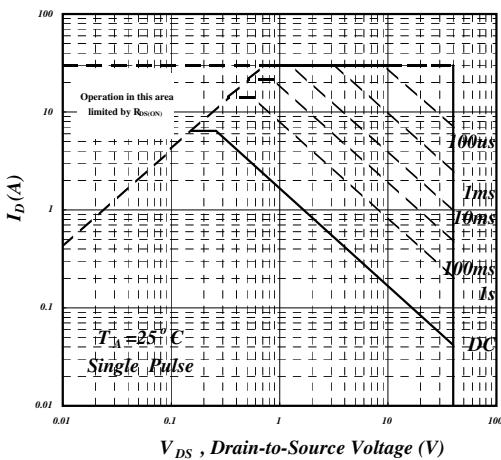
## **N-Channel**



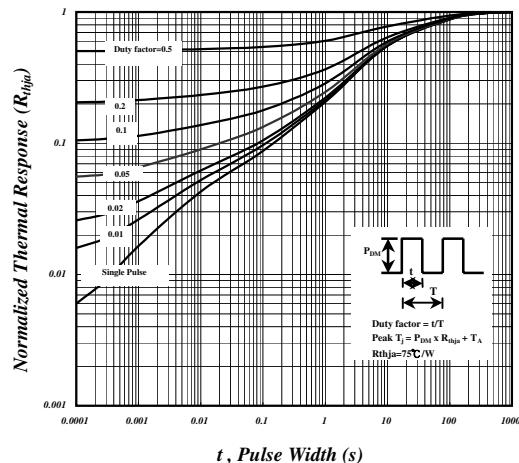
### **Fig 7. Gate Charge Characteristics**



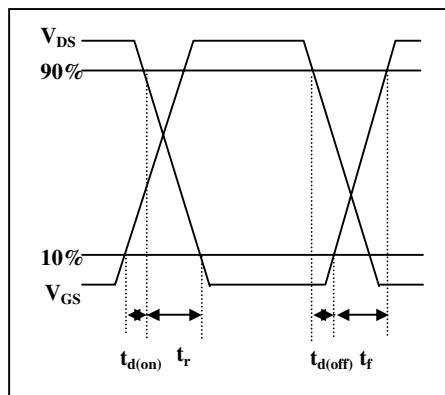
### **Fig 8. Typical Capacitance Characteristics**



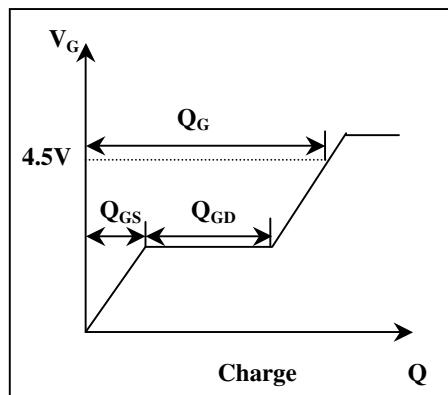
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**



**Fig 11. Switching Time Waveform**

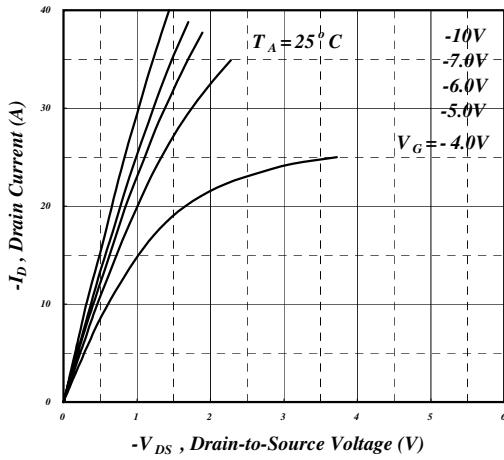


**Fig 12. Gate Charge Waveform**

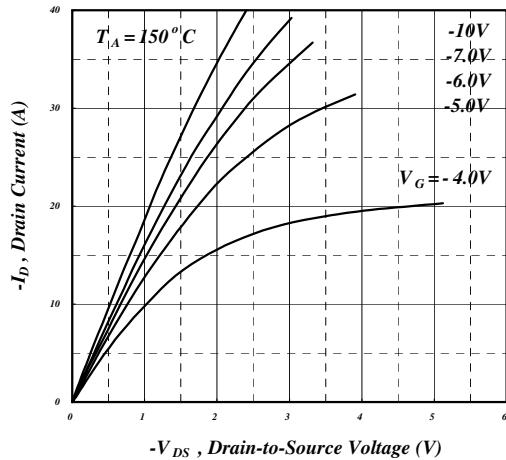
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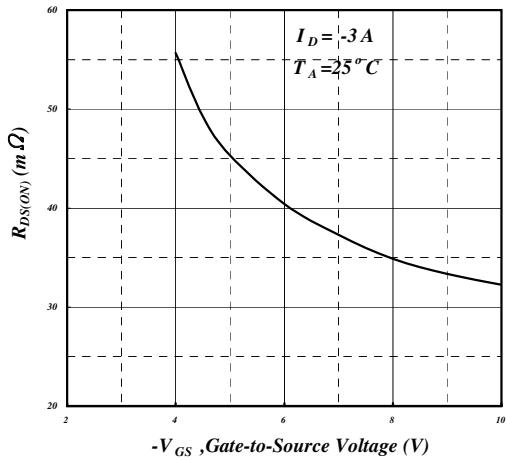
P-Channel



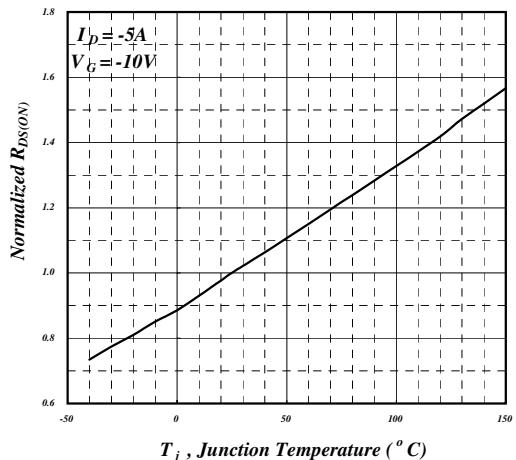
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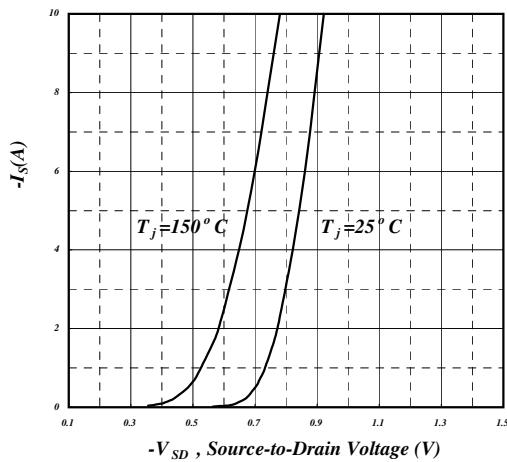
**Fig 2. Typical Output Characteristics**



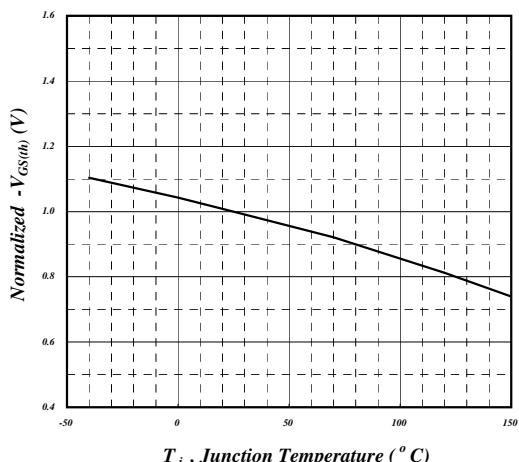
**Fig 3. On-Resistance v.s. Gate Voltage**



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**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



## P-Channel

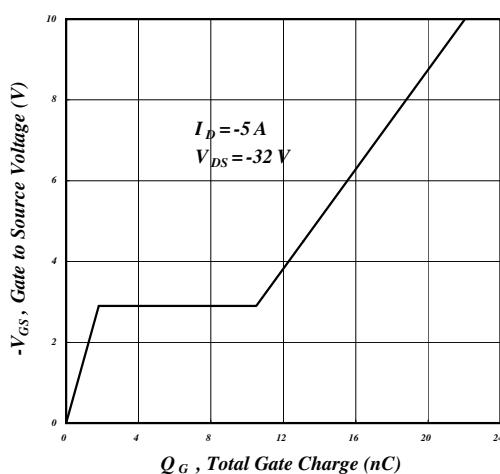


Fig 7. Gate Charge Characteristics

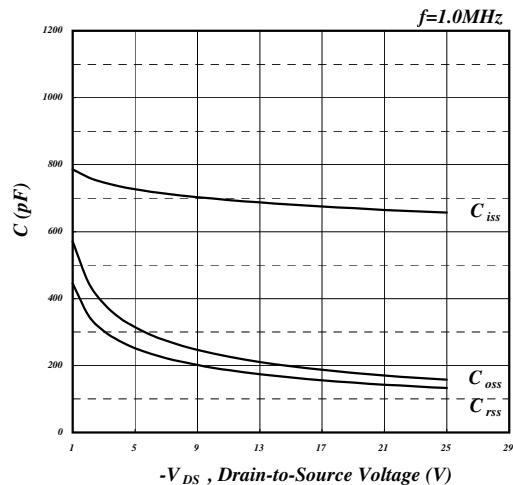


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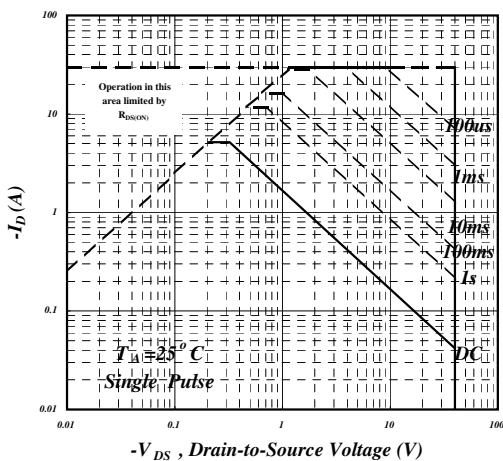


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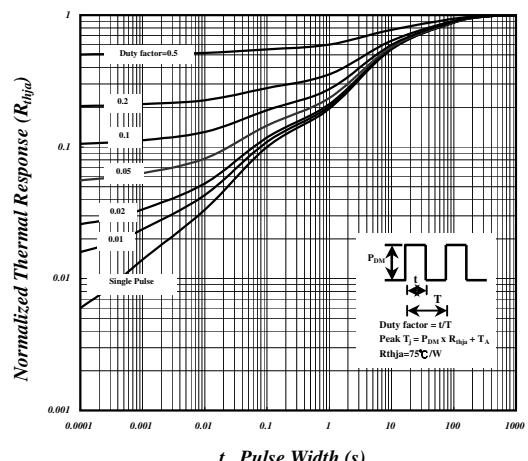


Fig 10. Effective Transient Thermal Impedance

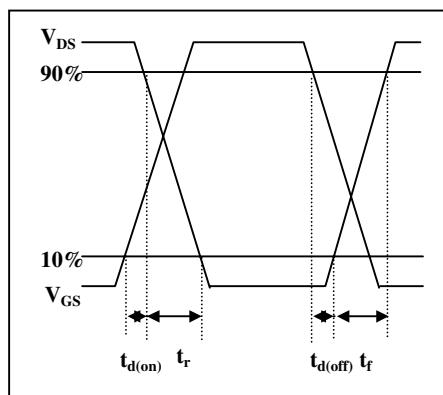


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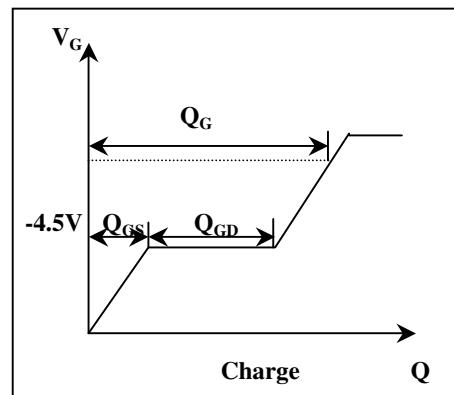


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